

LP3999 Low Noise 150mA Voltage Regulator for RF/Analog Applications

Check for Samples: [LP3999](#)

FEATURES

- 5 pin DSBGA Package
- Stable with Ceramic Capacitor
- Logic Controlled Enable
- Fast Turn-on
- Thermal-overload and short-circuit protection
- -40 to $+125^{\circ}\text{C}$ junction temperature range for operation

KEY SPECIFICATIONS

- 2.5V to 6.0V Input Range
- Accurate Output Voltage; $\pm 75\text{mV} / 2\%$
- 60 mV Typical Dropout with 150 mA Load. $V_{\text{out}} > 2.5\text{V}$
- Virtually Zero Quiescent Current when Disabled
- 10 μV_{rms} Output Noise Over 10Hz to 100kHz
- Stable with a 1 μF Output Capacitor
- Ensured 150 mA Output Current
- Fast Turn-on Time; 140 μs (Typ.)

APPLICATIONS

- GSM Portable Phones
- CDMA Cellular Handsets
- Wideband CDMA Cellular Handsets
- Bluetooth Devices
- Portable Information Appliances
- Handheld MP3 Devices

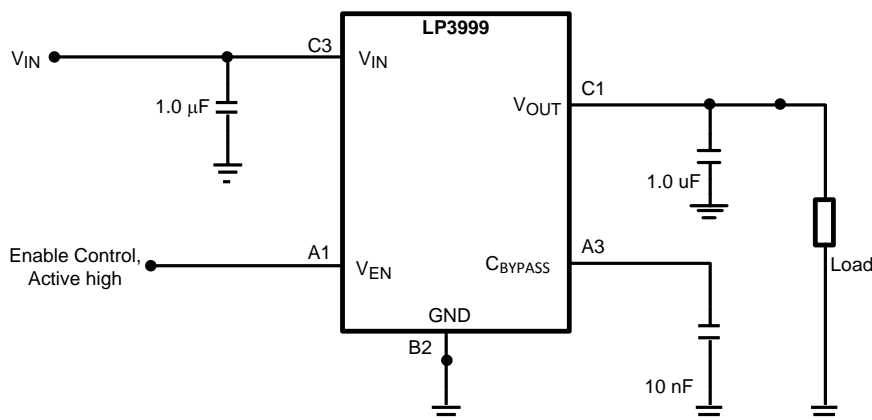
DESCRIPTION

The LP3999 regulator is designed to meet the requirements of portable wireless battery-powered applications and will provide an accurate output voltage with low noise and low quiescent current. Ideally suited for powering RF/Analog devices this device will also be used to meet more general circuit requirements.

For battery powered applications the low dropout and low ground current provided by the device allows the lifetime of the battery to be maximized. The inclusion of an Enable(disable) control can be used by the system to further extend the battery lifetime by reducing the power consumption to virtually zero. Should the application require a device with an active disable function please refer to device LP3995.

The LP3999 also features internal protection against short-circuit currents and over-temperature conditions.

Typical Application Circuit



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DESCRIPTION (CONTINUED)

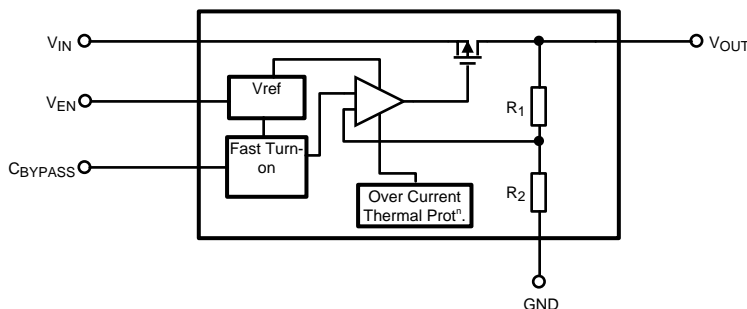
The LP3999 is designed to be stable with small 1.0 μF ceramic capacitors. The small outline of the LP3999 DSBGA package with the required ceramic capacitors can realize a system application within minimal board area.

Performance is specified for a -40°C to $+125^{\circ}\text{C}$ temperature range.

The device is available in DSBGA package. For other package options contact your local TI sales office.

The device is available in fixed output voltages in the ranges of 1.5V to 3.3V. For availability, please contact your local TI sales office.

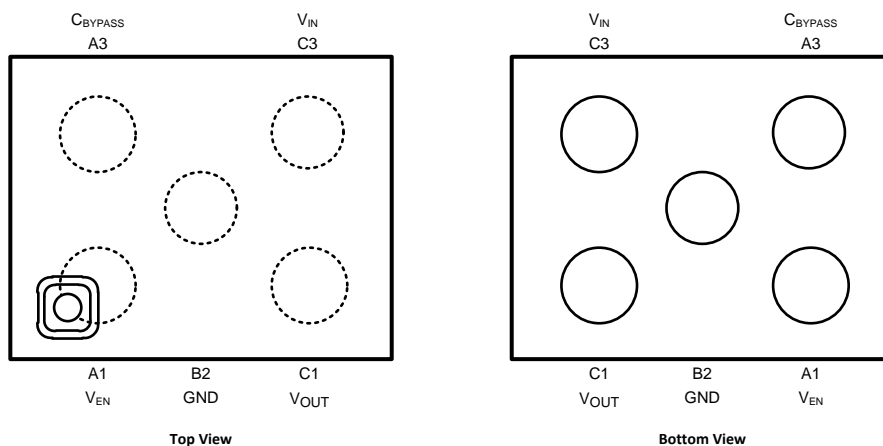
Block Diagram



PIN DESCRIPTIONS

Pin No.	Symbol	Name and Function
A1	V_{EN}	Enable Input; Disables the Regulator when $\leq 0.4\text{V}$. Enables the regulator when $\geq 0.9\text{V}$
B2	GND	Common Ground
C1	V_{OUT}	Voltage output. Connect this output to the load circuit.
C3	V_{IN}	Voltage Supply Input
A3	C_{BYPASS}	Bypass Capacitor connection. Connect a 0.01 μF capacitor for noise reduction.

Connection Diagram



5 Bump DSBGA Package
See Package Number YZR0005



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ORDERING INFORMATION⁽¹⁾⁽²⁾

Orderable Device	Output Voltage (V)
LP399ITL-1.5/NOPB	1.5
LP399ITLX-1.5/NOPB	
LP399ITL-1.8/NOPB	1.8
LP399ITLX-1.8/NOPB	
LP399ITL-1.875/NOPB	1.875
LP399ITLX-1.875/NOPB	
LP399ITL-2.4/NOPB	2.4
LP399ITLX-2.4/NOPB	
LP399ITL-2.5/NOPB	2.5
LP399ITLX-2.5/NOPB	
LP399ITL-2.8/NOPB	2.8
LP399ITLX-2.8/NOPB	
LP399ITL-3.3/NOPB	3.3
LP399ITLX-3.3/NOPB	

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.
 (2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

Absolute Maximum Ratings⁽¹⁾⁽²⁾⁽³⁾

Input Voltage (V_{IN})	-0.3 to 6.5V
Output Voltage	-0.3 to ($V_{IN} + 0.3V$) to 6.5V (max)
Enable Input Voltage	-0.3 to 6.5V
Junction Temperature	150°C
Lead/Pad Temperature ⁽⁴⁾	
DSBGA	260°C
Storage Temperature	-65 to +150°C
Continuous Power Dissipation ⁽⁵⁾	Internally limited
ESD ⁽⁶⁾	
Human Body Model	2 kV
Machine Model	200V

- (1) Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating Ratings are conditions under which operation of the device is ensured. Operating Ratings do not imply ensured performance limits. For ensured performance limits and associated test conditions, see the Electrical Characteristics tables.
 (2) All voltages are with respect to the potential at the GND pin.
 (3) **If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office / Distributors for availability and specifications.**
 (4) For further information on these packages please refer to application notes AN-1112 Micro SMD Package Wafer Level Chip Scale Package [SNVA009](#).
 (5) Internal Thermal shutdown circuitry protects the device from permanent damage.
 (6) The human body is 100 pF discharge through 1.5 kΩ resistor into each pin. The machine model is a 200 pF capacitor discharged directly into each pin.

Operating Ratings ⁽¹⁾

Input Voltage (V _{IN})	2.5 to 6.0V
Enable Input Voltage	0 to 6.0V
Junction Temperature	-40 to +125°C
Ambient Temperature Range ⁽²⁾	-40 to 85°C

- (1) Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating Ratings are conditions under which operation of the device is ensured. Operating Ratings do not imply ensured performance limits. For ensured performance limits and associated test conditions, see the Electrical Characteristics tables.
- (2) In applications where high power dissipation and/or poor thermal resistance is present, the maximum ambient temperature may have to be derated. Maximum ambient temperature (T_{A(max)}) is dependant on the maximum operating junction temperature (T_{J(max-op)}), the maximum power dissipation (P_{D(max)}), and the junction to ambient thermal resistance in the application (θ_{JA}). This relationship is given by:
- $$T_{A(max)} = T_{J(max-op)} - (P_{D(max)} \times \theta_{JA})$$

Thermal Properties⁽¹⁾

Junction to Ambient Thermal Resistance	
θ _{JA} (DSBGA pkg.)	255°C/W

- (1) Junction to ambient thermal resistance is highly dependant on the application and board layout. In applications where high thermal dissipation is possible, special care must be paid to thermal issues in the board design.

Electrical Characteristics

Unless otherwise noted, V_{EN} = 1.5, V_{IN} = V_{OUT(NOM)} + 1.0V, C_{IN} = 1 μF, I_{OUT} = 1 mA, C_{OUT} = 1 μF, C_{BP} = 0.01 μF. Typical values and limits appearing in normal type apply for T_J = 25°C. Limits appearing in **boldface** type apply over the full temperature range for operation, -40 to +125°C. ⁽¹⁾ ⁽²⁾

Symbol	Parameter	Conditions	Typical	Limit		Units
				Min	Max	
V _{IN}	Input Voltage			2.5	6.0	V
DEVICE OUTPUT: 1.5 ≤ V_{OUT} < 1.8V						
ΔV _{OUT}	Output Voltage Tolerance	I _{OUT} = 1 mA		-50	50	mV
				-75	75	
	Line Regulation Error	V _{IN} = (V _{OUT(NOM)} +1.0V) to 6.0V, I _{OUT} = 1 mA		-3.5	3.5	mV/V
	Load Regulation Error	I _{OUT} = 1 mA to 150 mA	10		75	μV/mA
PSRR	Power Supply Rejection Ratio ⁽³⁾	f = 1 kHz, I _{OUT} = 1 mA	58			dB
		f = 10 kHz, I _{OUT} = 1 mA	58			
DEVICE OUTPUT: 1.8 ≤ V_{OUT} < 2.5V						
ΔV _{OUT}	Output Voltage Tolerance	I _{OUT} = 1 mA		-50	50	mV
				-75	75	
	Line Regulation Error	V _{IN} = (V _{OUT(NOM)} +1.0V) to 6.0V, I _{OUT} = 1 mA		-2.5	2.5	mV/V
	Load Regulation Error	I _{OUT} = 1 mA to 150 mA	10		75	μV/mA
PSRR	Power Supply Rejection Ratio ⁽³⁾	f = 1 kHz, I _{OUT} = 1 mA	60			dB
		f = 10 kHz, I _{OUT} = 1 mA	60			
DEVICE OUTPUT: 2.5 ≤ V_{OUT} ≤ 3.3V						
ΔV _{OUT}	Output Voltage Tolerance	I _{OUT} = 1 mA		-2	2	% of V _{OUT(NOM)}
				-3	3	
	Line Regulation Error	V _{IN} = (V _{OUT(NOM)} +1.0V) to 6.0V, I _{OUT} = 1 mA		-0.1	0.1	%/V
	Load Regulation Error	I _{OUT} = 1 mA to 150 mA	0.0004		0.002	%/mA

- (1) All limits are ensured. All electrical characteristics having room-temperature limits are tested during production at T_J = 25°C or correlated using Statistical Quality Control methods. Operation over the temperature specification is ensured by correlating the electrical characteristics to process and temperature variations and applying statistical process control.
- (2) V_{OUT(NOM)} is the stated output voltage option for the device.
- (3) This electrical specification is ensured by design.

Electrical Characteristics (continued)

Unless otherwise noted, $V_{EN} = 1.5$, $V_{IN} = V_{OUT(NOM)} + 1.0V$, $C_{IN} = 1 \mu F$, $I_{OUT} = 1$ mA, $C_{OUT} = 1 \mu F$, $C_{BP} = 0.01 \mu F$. Typical values and limits appearing in normal type apply for $T_J = 25^\circ C$. Limits appearing in **boldface** type apply over the full temperature range for operation, -40 to $+125^\circ C$. ⁽¹⁾ ⁽²⁾

Symbol	Parameter	Conditions	Typical	Limit		Units
				Min	Max	
V _{DO}	Dropout Voltage	I _{OUT} = 1 mA	0.4		2	mV
		I _{OUT} = 150 mA	60		100	
PSRR	Power Supply Rejection Ratio ⁽³⁾	f = 1 kHz, I _{OUT} = 1 mA	60			dB
		f = 10 kHz, I _{OUT} = 1 mA	50			
FULL V_{OUT} RANGE						
I _{LOAD}	Load Current	See ⁽⁴⁾ and ⁽³⁾		0		μA
I _Q	Quiescent Current	V _{EN} = 1.5V, I _{OUT} = 0 mA	85		150	μA
		V _{EN} = 1.5V, I _{OUT} = 150 mA	140		200	
		V _{EN} = 0.4V	0.003		1.5	
I _{SC}	Short Circuit Current Limit		450			mA
E _N	Output Noise Voltage ⁽³⁾	BW = 10 Hz to 100 kHz, V _{IN} = 4.2V, No Load	10			μVrms
		BW = 10 Hz to 100 kHz, V _{IN} = 4.2V, 1mA Load	30			
T _{SHUTDOWN}	Thermal Shutdown	Temperature	160			°C
		Hysteresis	20			
ENABLE CONTROL CHARACTERISTICS						
I _{EN}	Maximum Input Current at V _{EN} Input	V _{EN} = 0.0V and V _{IN} = 6.0V	0.001			μA
V _{IL}	Low Input Threshold				0.4	V
V _{IH}	High Input Threshold			0.9		V
TIMING CHARACTERISTICS						
T _{ON}	Turn On Time ⁽⁵⁾	To 95% Level ⁽⁶⁾	140			μs

(4) The device maintains the regulated output voltage without load.

(5) This electrical specification is ensured by design.

(6) Time from V_{EN} = 0.9V to V_{OUT} = 95% (V_{OUT(NOM)})

Recommended Output Capacitor

Symbol	Parameter	Conditions	Typical	Limit		Units
				Min	Max	
C _{OUT}	Output Capacitor	Capacitance ⁽¹⁾	1.0	0.70		μF
		ESR		5	500	mΩ

(1) The capacitor tolerance should be 30% or better over temperature. Recommended capacitor type is X7R however dependant on application X5R, Y5V and Z5U can also be used.

INPUT TEST SIGNALS

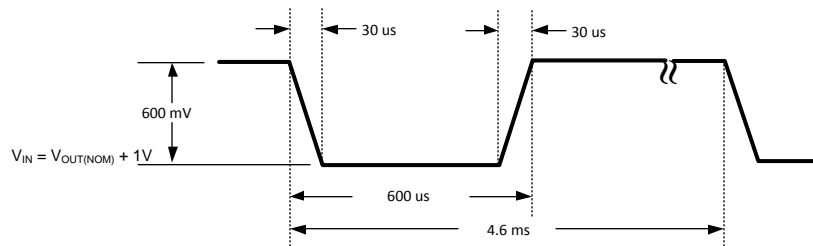


Figure 1. Line Transient Response Input Test Signal

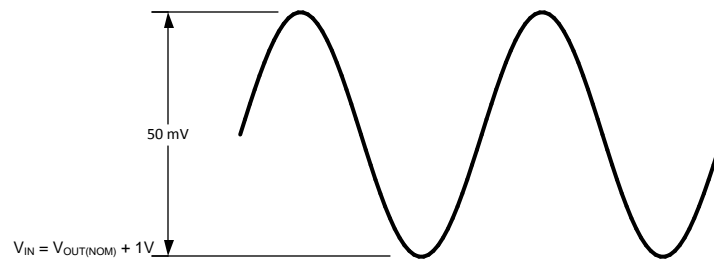


Figure 2. PSRR Input Test Signal

TYPICAL PERFORMANCE CHARACTERISTICS

Unless otherwise specified, $C_{IN} = C_{OUT} = 1.0 \mu\text{F}$ Ceramic, $V_{IN} = V_{OUT} + 1.0\text{V}$, $T_A = 25^\circ\text{C}$, Enable pin is tied to V_{IN} .

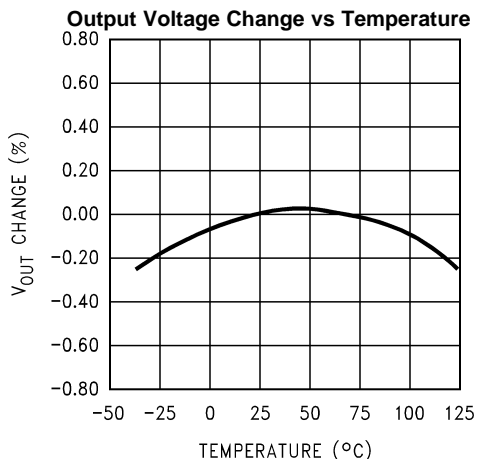


Figure 3.

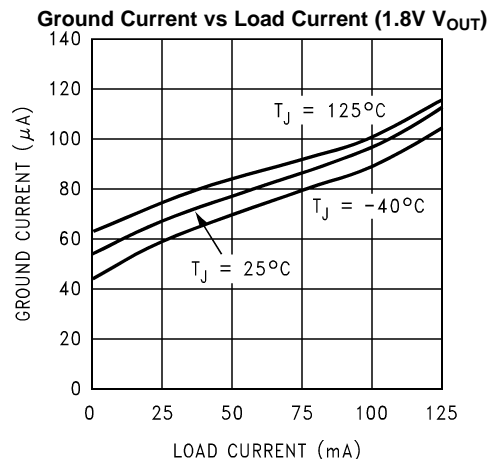


Figure 4.

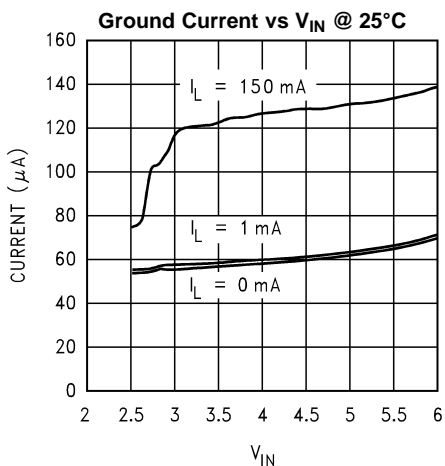


Figure 5.

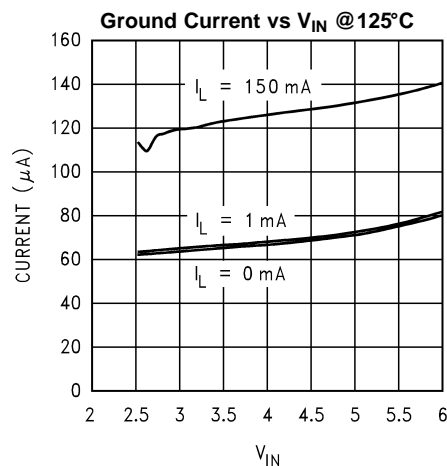


Figure 6.

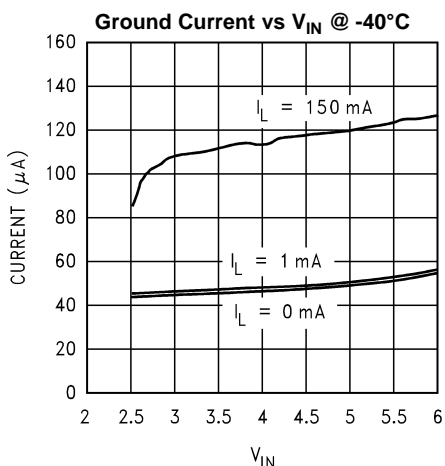


Figure 7.

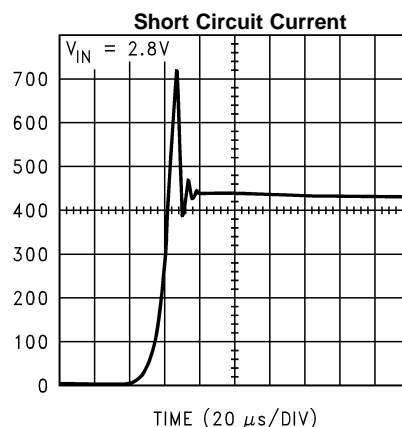


Figure 8.

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

Unless otherwise specified, $C_{IN} = C_{OUT} = 1.0 \mu\text{F}$ Ceramic, $V_{IN} = V_{OUT} + 1.0\text{V}$, $T_A = 25^\circ\text{C}$, Enable pin is tied to V_{IN} .

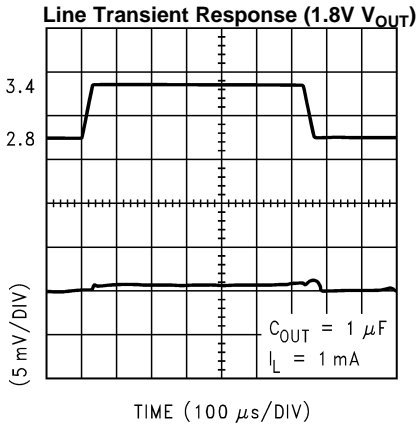


Figure 9.

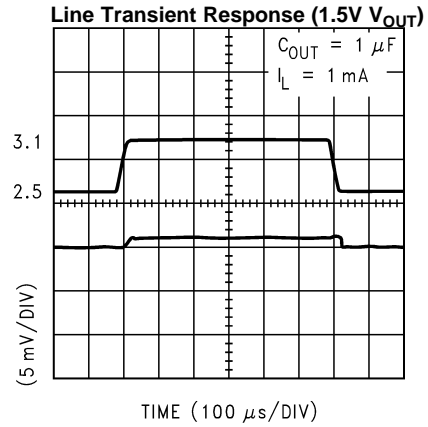


Figure 10.

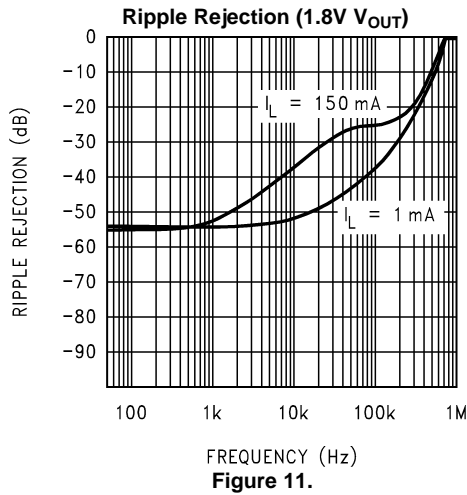


Figure 11.

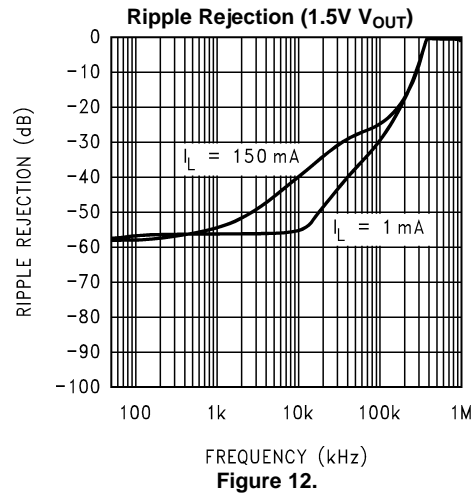


Figure 12.

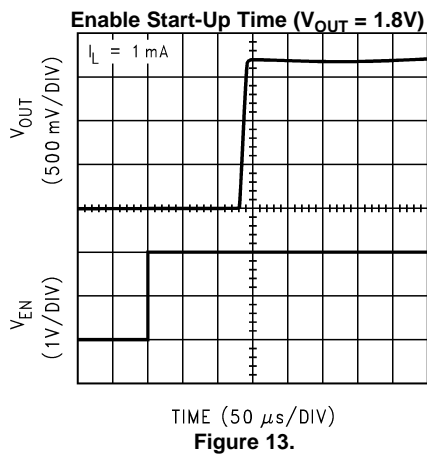


Figure 13.

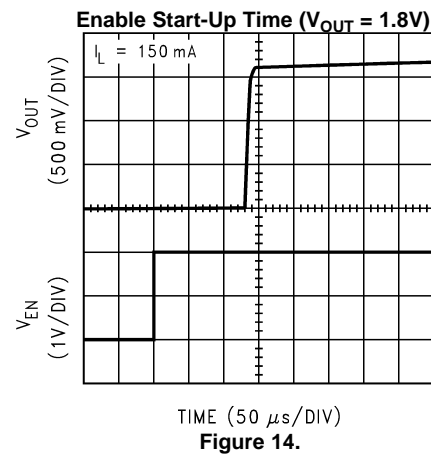


Figure 14.

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

Unless otherwise specified, $C_{IN} = C_{OUT} = 1.0 \mu\text{F}$ Ceramic, $V_{IN} = V_{OUT} + 1.0\text{V}$, $T_A = 25^\circ\text{C}$, Enable pin is tied to V_{IN} .

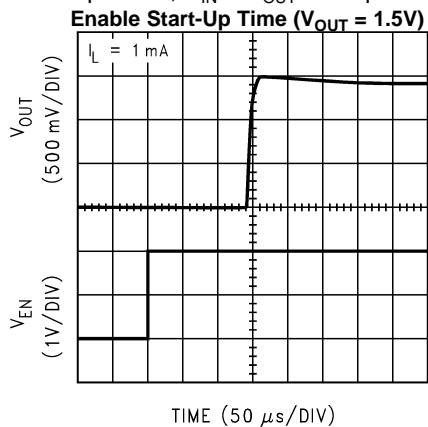


Figure 15.

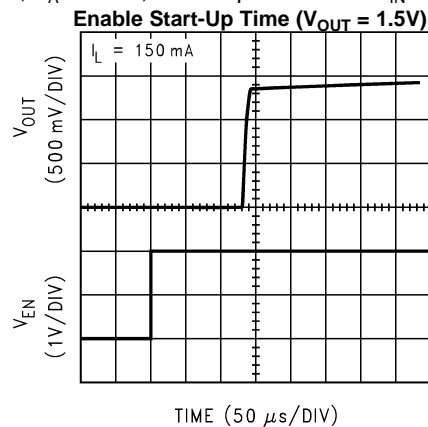


Figure 16.

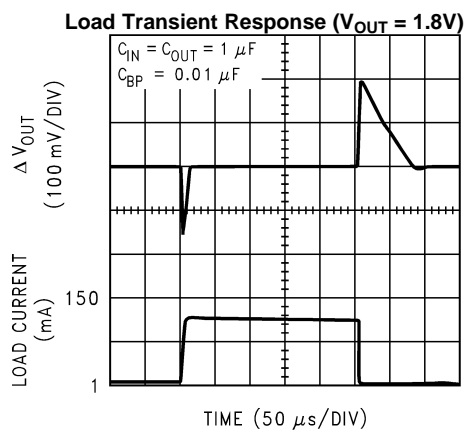


Figure 17.

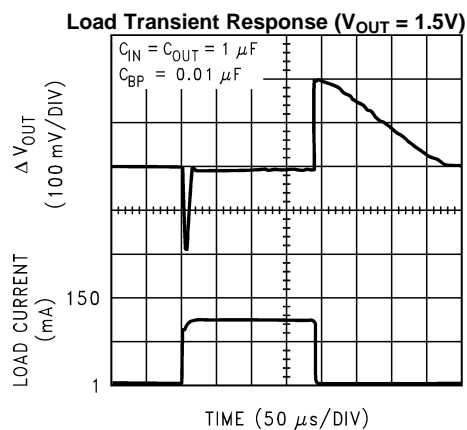


Figure 18.

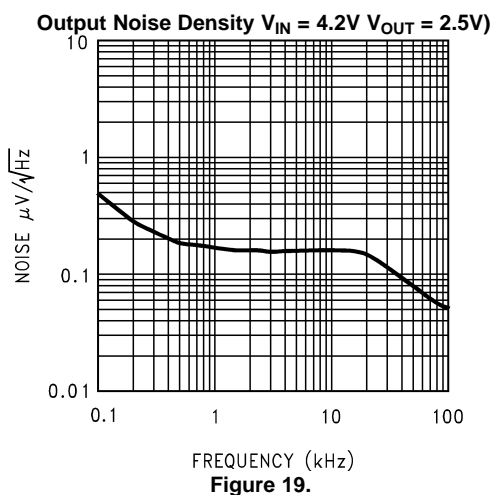


Figure 19.

APPLICATION HINTS

POWER DISSIPATION AND DEVICE OPERATION

The permissible power dissipation for any package is a measure of the capability of the device to pass heat from the power source, the junctions of the IC, to the ultimate heat sink, the ambient environment. Thus the power dissipation is dependent on the ambient temperature and the thermal resistance across the various interfaces between the die and ambient air.

Re-stating the equation given in ⁽¹⁾ in the electrical specification section, the allowable power dissipation for the device in a given package can be calculated:

$$P_D = \frac{(T_{J(\text{MAX})} - T_A)}{\theta_{JA}} \quad (1)$$

With a $\theta_{JA} = 255^\circ\text{C/W}$, the device in the DSBGA package returns a value of 392 mW with a maximum junction temperature of 125°C .

The actual power dissipation across the device can be represented by the following equation:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} \quad (2)$$

This establishes the relationship between the power dissipation allowed due to thermal consideration, the voltage drop across the device, and the continuous current capability of the device. These two equations should be used to determine the optimum operating conditions for the device in the application.

EXTERNAL CAPACITORS

In common with most regulators, the LP3999 requires external capacitors to ensure stable operation. The LP3999 is specifically designed for portable applications requiring minimum board space and smallest components. These capacitors must be correctly selected for good performance.

INPUT CAPACITOR

An input capacitor is required for stability. It is recommended that a 1.0 μF capacitor be connected between the LP3999 input pin and ground (this capacitance value may be increased without limit).

This capacitor must be located a distance of not more than 1 cm from the input pin and returned to a clean analogue ground. Any good quality ceramic, tantalum, or film capacitor may be used at the input.

Important: Tantalum capacitors can suffer catastrophic failures due to surge current when connected to a low-impedance source of power (like a battery or a very large capacitor). If a tantalum capacitor is used at the input, it must be ensured by the manufacturer to have a surge current rating sufficient for the application.

There are no requirements for the **ESR** (Equivalent Series Resistance) on the input capacitor, but tolerance and temperature coefficient must be considered when selecting the capacitor to ensure the capacitance will remain $\approx 1.0 \mu\text{F}$ over the entire operating temperature range.

OUTPUT CAPACITOR

The LP3999 is designed specifically to work with very small ceramic output capacitors. A ceramic capacitor (dielectric types Z5U, Y5V or X7R) in the 1.0 [to 10 μF] range, and with ESR between 5 m Ω to 500 m Ω , is suitable in the LP3999 application circuit.

For this device the output capacitor should be connected between the V_{OUT} pin and ground.

It may also be possible to use tantalum or film capacitors at the device output, V_{OUT} , but these are not as attractive for reasons of size and cost (see the section [CAPACITOR CHARACTERISTICS](#)).

The output capacitor must meet the requirement for the minimum value of capacitance and also have an ESR value that is within the range 5 m Ω to 500 m Ω for stability.

(1) In applications where high power dissipation and/or poor thermal resistance is present, the maximum ambient temperature may have to be derated. Maximum ambient temperature ($T_{A(\text{max})}$) is dependant on the maximum operating junction temperature ($T_{J(\text{max-op})}$), the maximum power dissipation ($P_{D(\text{max})}$), and the junction to ambient thermal resistance in the application (θ_{JA}). This relationship is given by:

$$T_{A(\text{max})} = T_{J(\text{max-op})} - (P_{D(\text{max})} \times \theta_{JA}).$$

NO-LOAD STABILITY

The LP3999 will remain stable and in regulation with no external load. This is an important consideration in some circuits, for example CMOS RAM keep-alive applications.

CAPACITOR CHARACTERISTICS

The LP3999 is designed to work with ceramic capacitors on the output to take advantage of the benefits they offer. For capacitance values in the range of 1 μF to 4.7 μF , ceramic capacitors are the smallest, least expensive and have the lowest ESR values, thus making them best for eliminating high frequency noise. The ESR of a typical 1 μF ceramic capacitor is in the range of 20 m Ω to 40 m Ω , which easily meets the ESR requirement for stability for the LP3999.

The temperature performance of ceramic capacitors varies by type. Most large value ceramic capacitors (≥ 2.2 μF) are manufactured with Z5U or Y5V temperature characteristics, which results in the capacitance dropping by more than 50% as the temperature goes from 25°C to 85°C.

A better choice for temperature coefficient in a ceramic capacitor is X7R. This type of capacitor is the most stable and holds the capacitance within $\pm 15\%$ over the temperature range. Tantalum capacitors are less desirable than ceramic for use as output capacitors because they are more expensive when comparing equivalent capacitance and voltage ratings in the 1 μF to 4.7 μF range.

Another important consideration is that tantalum capacitors have higher ESR values than equivalent size ceramics. This means that while it may be possible to find a tantalum capacitor with an ESR value within the stable range, it would have to be larger in capacitance (which means bigger and more costly) than a ceramic capacitor with the same ESR value. It should also be noted that the ESR of a typical tantalum will increase about 2:1 as the temperature goes from 25°C down to -40°C, so some guard band must be allowed.

NOISE BYPASS CAPACITOR

A bypass capacitor should be connected between the C_{BYPASS} pin and ground to significantly reduce the noise at the regulator output. This device pin connects directly to a high impedance node within the bandgap reference circuitry. Any significant loading on this node will cause a change on the regulated output voltage. For this reason, DC leakage current through this pin must be kept as low as possible for best output voltage accuracy.

The use of a 0.01 μF bypass capacitor is strongly recommended to prevent overshoot on the output during start-up.

The types of capacitors best suited for the noise bypass capacitor are ceramic and film. High quality ceramic capacitors with NPO or COG dielectric typically have very low leakage. Polypropylene and polycarbonate film capacitors are available in small surface-mount packages and typically have extremely low leakage current.

Unlike many other LDO's, the addition of a noise reduction capacitor does not effect the transient response of the device.

ENABLE OPERATION

The LP3999 may be switched ON or OFF by a logic input at the ENABLE pin, V_{EN} . A high voltage at this pin will turn the device on. When the enable pin is low, the regulator output is off and the device typically consumes 3 nA. If the application does not require the shutdown feature, the V_{EN} pin should be tied to V_{IN} to keep the regulator output permanently on. To ensure proper operation, the signal source used to drive the V_{EN} input must be able to swing above and below the specified turn-on/off voltage thresholds listed in the Electrical Characteristics section under V_{IL} and V_{IH} .

FAST TURN ON

Fast turn-on is ensured by control circuitry within the reference block allowing a very fast ramp of the output voltage to reach the target voltage. There is no active turn-off on this device. Refer to LP3995 for a similar device with active turn-off.

DSBGA MOUNTING

The DSBGA package requires specific mounting techniques which are detailed in TI's AN-1112 Application Report ([SNVA009](#)).

Referring to the section *Surface Mount Assembly Considerations*, it should be noted that the pad style which must be used with the 5 pin package is NSMD (non-solder mask defined) type.

For best results during assembly, alignment ordinals on the PC board may be used to facilitate placement of the DSBGA device.

DSBGA LIGHT SENSITIVITY

Exposing the DSBGA device to direct sunlight will cause incorrect operation of the device. Light sources such as halogen lamps can affect electrical performance if they are situated in proximity to the device.

Light with wavelengths in the red and infra-red part of the spectrum have the most detrimental effect thus the fluorescent lighting used inside most buildings has very little effect on performance. Tests carried out on a DSBGA test board showed a negligible effect on the regulated output voltage when brought within 1 cm of a fluorescent lamp. A deviation of less than 0.1% from nominal output voltage was observed.

REVISION HISTORY

Changes from Revision D (May 2013) to Revision E	Page
<hr/> <ul style="list-style-type: none">• Changed layout of National Data Sheet to TI format	<hr/> 12

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LP3999ITL-1.8/NOPB	Active	Production	DSBGA (YZR) 5	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITL-1.8/NOPB.A	Active	Production	DSBGA (YZR) 5	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITL-2.4/NOPB	Active	Production	DSBGA (YZR) 5	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITL-2.4/NOPB.A	Active	Production	DSBGA (YZR) 5	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITL-2.5/NOPB	Active	Production	DSBGA (YZR) 5	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITL-2.5/NOPB.A	Active	Production	DSBGA (YZR) 5	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITL-3.3/NOPB	Active	Production	DSBGA (YZR) 5	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITL-3.3/NOPB.A	Active	Production	DSBGA (YZR) 5	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITLX-1.8/NO.A	Active	Production	DSBGA (YZR) 5	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITLX-1.8/NOPB	Active	Production	DSBGA (YZR) 5	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITLX-2.5/NO.A	Active	Production	DSBGA (YZR) 5	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITLX-2.5/NOPB	Active	Production	DSBGA (YZR) 5	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITLX-2.8/NO.A	Active	Production	DSBGA (YZR) 5	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITLX-2.8/NOPB	Active	Production	DSBGA (YZR) 5	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITLX-3.3/NO.A	Active	Production	DSBGA (YZR) 5	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9
LP3999ITLX-3.3/NOPB	Active	Production	DSBGA (YZR) 5	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	9

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

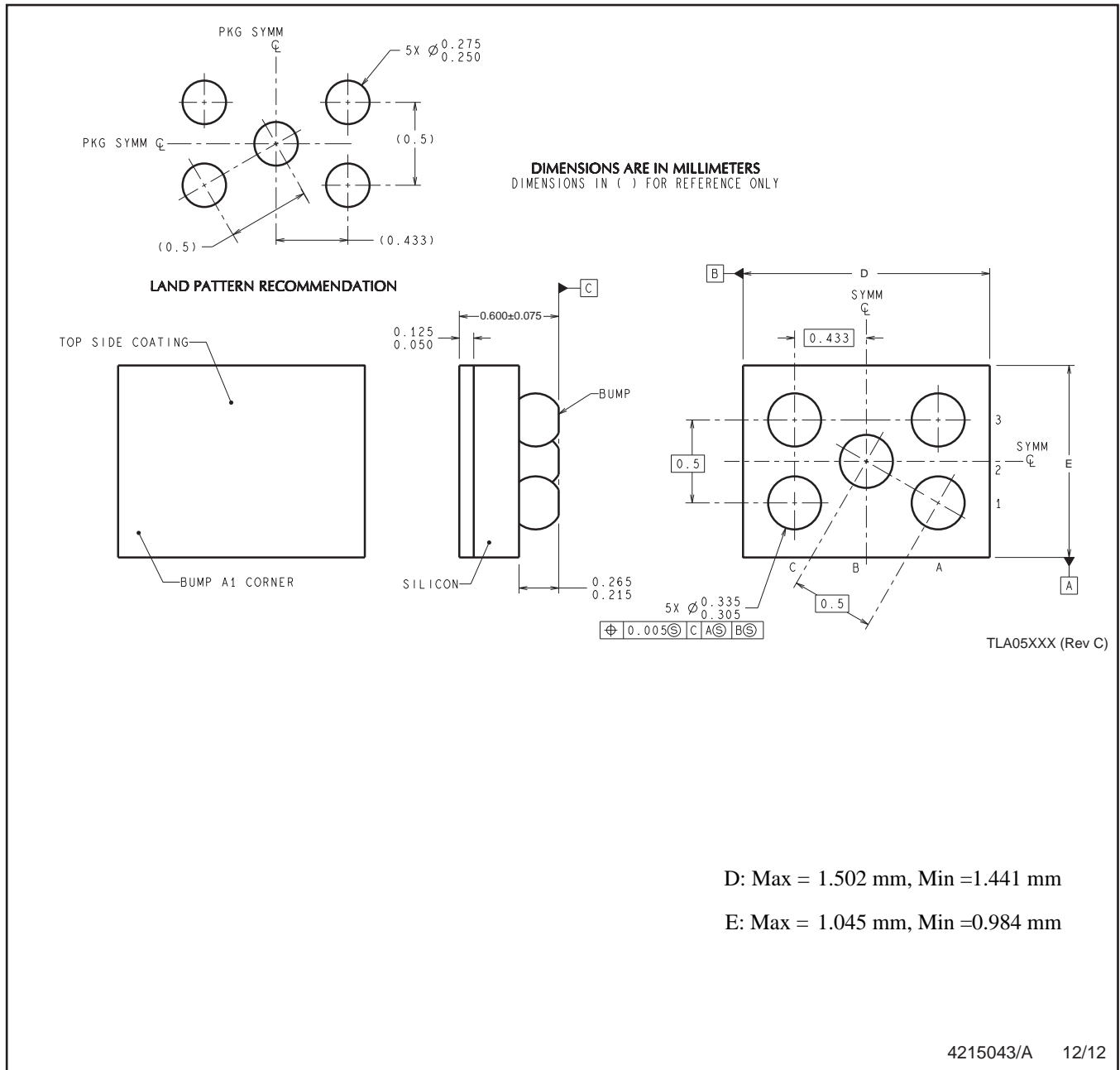
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP3999ITL-1.8/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3999ITL-2.4/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3999ITL-2.5/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3999ITL-3.3/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3999ITLX-1.8/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3999ITLX-2.5/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3999ITLX-2.8/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3999ITLX-3.3/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP3999ITL-1.8/NOPB	DSBGA	YZR	5	250	208.0	191.0	35.0
LP3999ITL-2.4/NOPB	DSBGA	YZR	5	250	208.0	191.0	35.0
LP3999ITL-2.5/NOPB	DSBGA	YZR	5	250	208.0	191.0	35.0
LP3999ITL-3.3/NOPB	DSBGA	YZR	5	250	208.0	191.0	35.0
LP3999ITLX-1.8/NOPB	DSBGA	YZR	5	3000	208.0	191.0	35.0
LP3999ITLX-2.5/NOPB	DSBGA	YZR	5	3000	208.0	191.0	35.0
LP3999ITLX-2.8/NOPB	DSBGA	YZR	5	3000	208.0	191.0	35.0
LP3999ITLX-3.3/NOPB	DSBGA	YZR	5	3000	208.0	191.0	35.0

YZR0005



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
B. This drawing is subject to change without notice.

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